

	Type	L #	Hits	Search Text	DBs
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6	BRS	L6	126	L1 and (bump or ball) and transparent and (image or sensor or optical)	US-PGPUB; USPAT; USOCR
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8	BRS	L11	5	((die or chip or semiconductor) and depression and transparent and (image or sensor or optical or opto) and conductive and exposed).clm.	US-PGPUB
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10	BRS	L12	383	257/433.ccls.	EPO; JPO; DERWENT; IBM_TDB

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11	BRS	L13	205	257/88.ccls.	EPO; JPO; DERWENT; IBM_TDB
12	BRS	L7	41	L2 and (bump or ball) and transparent and (image or sensor or optical)	US-PGPUB; USPAT; USOCR
13	BRS	L9	60	L4 and (bump or ball) and transparent and (image or sensor or optical)	US-PGPUB; USPAT; USOCR